

USB Dedicated Charging Port Controller for Fast Charging Protocol and QC 2.0/3.0

Description

The FP6601Q is a fast charging protocol controller for HiSilicon Fast Charging Protocol (FCP) and Qualcomm[®] Quick ChargeTM 2.0/3.0 (QC 2.0/3.0) USB interface. The FP6601Q monitors USB D+/D- data line and automatically adjusts the output voltage depending on different powered device (PD). The charging time of PD is therefore optimized by the FP6601Q.

FP6601Q can support not only USB BC compliant devices, but also Apple / Samsung / HUAWEI devices and automatically detects whether a connected powered device is QC 2.0/3.0 or FCP capable before enabling output voltage adjustment. If a PD is not compliant with QC 2.0/3.0 and FCP, the FP6601Q will disable the adjustment of output voltage and keep the default 5V output voltage for safe operation.

The FP6601Q is available in a space-saving SOT-23-6 package.

Features

- Supports HiSilicon Fast Charging Protocol (FCP)
- Supports Qualcomm[®] Quick Charge[™] 2.0/3.0 Class A: 3.6V up to 12V Output Voltage
- Automatically Selects FCP and QC2.0/3.0 Protocols
- Supports USB DCP Shorting D+ Line to D- Line per USB Battery Charging Specification, Revision 1.2
- Complies with Chinese Telecommunication Industry Standard YD/T 1591-2009
- Supports USB DCP Applying 2.7V on D+ Line and 2.7V on D- Line
- SOT-23-6 Package
- UL Certification No. 4787452994-2

Applications

- Wall-Adapter, Smart Phones, Tablets, Notebooks
- Mobile / Tablet Power Bank
- Car Charger
- USB Power Output Ports

Pin Assignments

S6 Package(SOT-23-6)

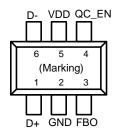


Figure 1. Pin Assignment of FP6601Q

Ordering Information



SOT-23-6 Marking

Part Number		Product Code	
FP	6601QS6	FT4	



Typical Application Circuit

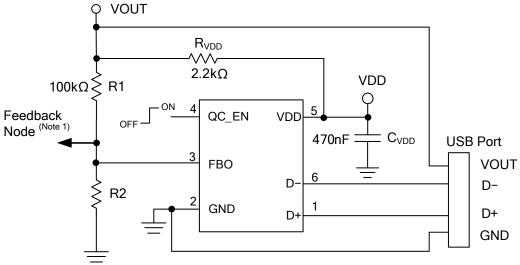


Figure 2. Typical Application Schematic

Note 1: The recommended voltage of feedback node ranges between 0.4V and 1.5V

Output Voltage Lookup Table(QC 2.0/3.0)

D+	D-	Output Voltage		
0.6V	0.6V	12V		
3.3V	0.6V	9V		
0.6V	3.3V	Continuous mode		
0.6V	High-Z	5V (Default)		

FP6601Q-1.3-JUN-2018 **2**



Functional Pin Description

Pin Name	Pin No.	Pin Function
D+	1	USB D+ data line. Recommended this pin connect without resistors(open) or with a resistor higher than $1M\Omega$ connect to GND.
GND	2	Ground pin.
FBO	3	Feedback output pin. Current sink/source FB node.
QC_EN	4	QC_enable: QC2.0/3.0 and FCP function are enabled by either logic high or high-Z. Contrarily, QC2.0/3.0 and FCP function are disabled by logic low.
VDD	5	Power supply input pin.
D-	6	USB D- data line.

Block Diagram

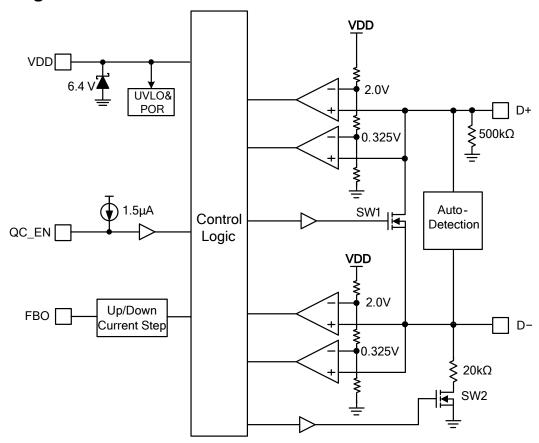


Figure 3. Block Diagram of FP6601Q



Absolute Maximum Ratings (Note 2)

Input Supply Voltage VDD	-0.3V to +7V
• D+,D-Pins Voltage	-0.3V to +14V
All Other Pins Voltage	-0.3V to +7V
Maximum Junction Temperature (T _J)	+150°C
Storage Temperature (T _S)	-65°C to +150°C
• Lead Temperature (Soldering, 10sec.)	+260°C
 Package Thermal Resistance, (θ_{JA}) (Note 3) 	
SOT-23-6	250°C/W
 Package Thermal Resistance, (θ_{JC}) 	
SOT-23-6	110°C/W

Note 2: Stresses beyond this listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Note 3: θ_{JA} is measured at 25°C ambient with the component mounted on a high effective thermal conductivity test board of JEDEC-51-7.

Recommended Operating Conditions

- Input Supply Voltage (VDD)-----++3.2V to +6.8V



Electrical Characteristics

(VDD=5V, T_A=25°C and the recommended supply voltage range, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Input Power							
VDD Input Voltage Range	V _{DD}		3.2		6.8	V	
Input UVLO Threshold	V _{UVLO(VTH)}	V _{DD} Falling	2.5		2.9	٧	
VDD Supply Current		V _{DD} =5V, Measure V _{DD}		180		μΑ	
VDD Shunt Voltage	V _{DD} (SHUNT)	IV _{DD} = 3mA	5.9	6.4	6.8	V	
High Voltage Dedicated Charging Port	(HVDCP)						
Data Detect Voltage	V _{DAT(REF)}		0.25	0.325	0.4	V	
Output Voltage Selection Reference	V _{SEL_REF}		1.8	2.0	2.2	V	
D+ High Glitch Filter Time	T _{GLITCH(BC)} -		1000	1250	1500	ms	
D- Low Glitch Filter Time	T _{GLITCH(BC)} -			1		ms	
Output Voltage Glitch Filter Time	T _{GLITCH(V)}		20	40	60	ms	
D- Pull-Down Resistance	R _{D-(DWN)}			20		kΩ	
Continuous Mode Glitch Filter Time (Note 4)	T _{GLITCH-CON}		100		200	μs	
D+ Leakage Resistance	R _{DAT-LKG}	V _{DD} =3.2-6.4V,VD+=0.6-3.6V Switch SW1=Off	300	500	800	kΩ	
Switch SW1 On-Resistance	R _{DS_ON_N1}	V _{DD} =5V,SW1= 200μA			40	Ω	
Up/Down Current Step	I _{UP} , I _{DOWN}	I _{UP} = 40μA (9V), 70μA (12V), I _{DOWN} = 14μA (3.6V)		2		μΑ	
Feedback Output Voltage	V _{FBO}		0.4		1.5	V	
DCP Charging Mode							
D+_0.48V/D0.48V Line Output Voltage			0.44	0.48	0.52	V	
D+_0.48V/D0.48V Line Output Impedance				900		kΩ	

FP6601Q-1.3-JUN-2018 5



Electrical Characteristics (Continued)

(VDD=5V, T_A=25°C and the recommended supply voltage range, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Apple Mode	<u> </u>					
D+_2.7v/D2.7v Line Output Voltage			2.57	2.7	2.84	V
D+_2.7v/D2.7v Line Output Impedance				33.6		kΩ
D- SECTION (FCP)	·					
D- FCP Tx Valid Output High	V _{TX-VOH}		2.55		3.6	V
D- FCP Tx Valid Output Low	V _{TX-VOL}				0.3	V
D- FCP Rx Valid Output High	V _{RX-VIH}		1.4		3.6	V
D- FCP Rx Valid Output Low	V _{RX-VIL}				1.0	V
D- Output Pull-Low Resistance (FCP) (Note 4)	R _{PD}		400	500	600	Ω
Unit Interval For FCP PHY Communication	UI	f _{CLK} = 125kHz	144	160	180	μs
Others	•		•			•
QC_EN High-Level Input Voltage	V _{IH}		1.2			V
QC_EN Low-Level Input Voltage	V _{IL}				0.4	V

Note 4: Not production tested.



Typical Performance Curves

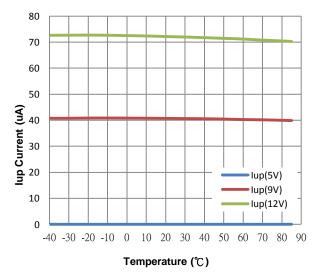


Figure 4. UP Current vs. Temperature

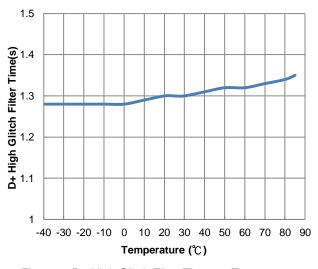


Figure 6. D+ High Glitch Filter Time vs. Temperature

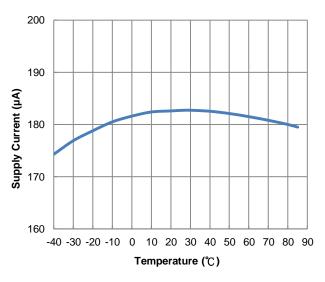


Figure 5. Supply Current vs. Temperature

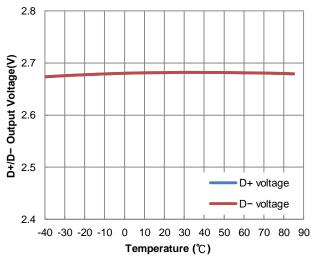


Figure 7. D+/D- Output Voltage vs. Temperature



Application Information

Function Description

The FP6601Q integrates both USB high voltage dedicated charging port interface IC for Qualcomm $^{\circledR}$ Quick Charge $^{\intercal M}$ 2.0/3.0 class A and HiSilicon FCP specification.

The FP6601Q can fast charge most of the handheld devices. It could be treated as the original charging adapter.

The FP6601Q supports BC1.2, Samsung and HUAWEI devices. It also supports output voltage range of QC 3.0 Class A (3.6V to 12V) or QC 2.0 Class A (5V, 9V, 12V).

Quick Charge 2.0/3.0 Interface

When the FP6601Q is powered on, D+ and D- pin are applied to 2.7V for Apple device. If handheld device has the function of QC 2.0/3.0, D+ pin will be forced between 0.325V and 2V. In the meanwhile, D+ pin will short to D- pin through the switch SW1 for entering BC 1.2. If D+ is continuously applied to the voltage between 0.325V and 2V for 1.25 seconds, the FP6601Q will enter QC 2.0/3.0 or FCP operation mode.

When the voltage of D+ pin and D- pin simultaneously satisfy these two inequalities $V_{DAT(REF)}$ < D+ < V_{SEL_REF} and D- > V_{SEL_REF} , the FP6601Q would enter continuous mode.

In the continuous mode, each voltage pulse on D+pin generated by powered device is between 1V and 3V. In the meanwhile, the high level of pulse should be keep at least 200us. If the specified conditions are satisfied, the FBO pin will sink 2uA per pulse. The maximum sink current is 70uA for output voltage 12V.

In the continuous mode, each voltage pulse on D-pin generated by powered device is between 3V and 1V. At the same time, the low level of pulse should be keep at least 200us. If the specified conditions are satisfied, the FBO pin will source 2uA per pulse. The maximum source current is 14uA for output voltage 3.6V.

If the powered device doesn't support QC 2.0, the FP6601Q will remain default output voltage 5V for safe operation. On the other hand, when USB cable is removed, the voltage of D+ pin is therefore lower than $V_{\text{DAT}(\text{REF})}$ and the output default voltage 5V is also applied.

Shunt Regulator

The VDD of FP6601Q is supplied by the wide output voltage through the external resistor RVDD. The internal Zener-Diode is utilized to clamp the VDD at 6.4V. The recommended value of RVDD and CVDD are $2.2k\Omega$ and 470nF, respectively.

QC EN Function

QC 2.0/3.0 and FCP function are disabled by connecting the QC_EN pin to ground. On the contrary, QC 2.0/3.0 and FCP function could be enabled by connecting QC_EN pin to VDD or high-Z. Additionally, when FP6601Q is already accessed QC 2.0/3.0 or FCP mode, the selected mode can't be changed by setting QC_EN pin.

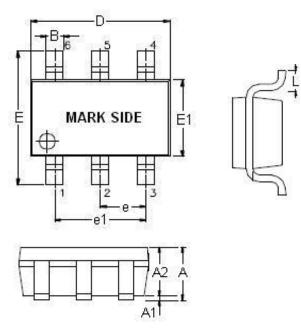
Data Line Protection

When D+/D- pin is touched by the output voltage in abnormal situation, the D+/D- pin of both sink device and source device may be damaged. In order to protect the D+/D- pin of the devices from damage in abnormal situation, the FP6601Q will return the output voltage to default output voltage 5V when the voltage of D+/D- pin is touched larger than 7.5V.



Outline Information

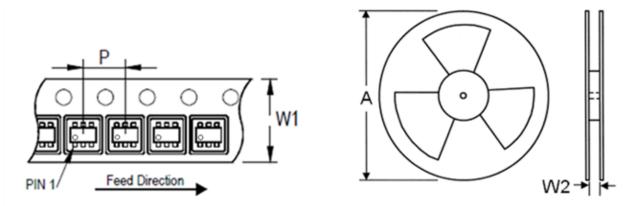
SOT-23-6 Package (Unit: mm)



SYMBOLS	DIMENSION IN MILLIMETER				
UNIT	MIN	MAX			
Α	0.90	1.45			
A1	0.00	0.15			
A2	0.90	1.30			
В	0.30	0.50			
D	2.80	3.00			
E	2.60	3.00			
E1	1.50	1.70			
е	0.90	1.00			
e1	1.80	2.00			
Ĺ	0.30	0.60			

Note: Followed From JEDEC MO-178-C.

Carrier Dimensions



Tape Size	Pocket Pitch	Reel Size (A)		Reel Width	Empty Cavity	Units per Reel
(W1) mm	(P) mm	in	mm	(W2) mm	Length mm	
8	4	7	180	8.4	300~1000	3,000